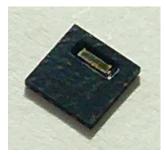
QM1H0P0073

Relative Humidity / Temperature Sensor



Description

QM1H0P0073 is a digital output relative humidity/temperature sensor. In addition to electrostatic capacitance type humidity sensor and temperature sensor elements, an analog-to-digital converter, signal processing unit, data storage for calibration data, and an interface circuit are integrated into 1 package. The device features wide operating range, small in size, high resolution and high response speed, and is suitable for use in a wide range of applications. Both the temperature and humidity sensors are factory-calibrated and no any further calibration is required after installing on electronic equipments.

Features

- High precision
 - Relative humidity: ±2%RH (typ.)
- Temperature: ±0.3°C(typ.)
- Wide operating range
- Relative humidity: 0 to 100%RH
- Temperature: -20 to 85°C
- Operating voltage: 2.7 to 5.5V
- Low power consumption
- 3.0uA (max) non-operation current
- I²C digital interface
- Small, Low profile QFN 16pin package
- footprint: 3mm × 3mm
- Industry-leading levels of height: 0.8mm
- Factory calibrated
- RoHS Compliant

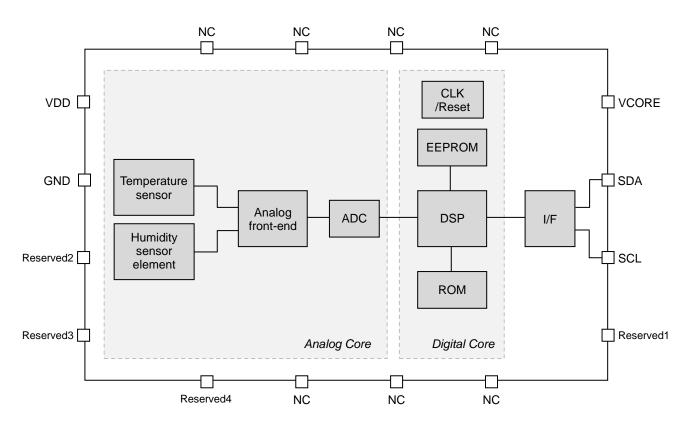
Applications

- Home electronics
 - Air conditioners, Air purifiers, Dehumidifiers
- Smart phones/Tablets
- Wearable devices
- Weather stations
- Wireless networks

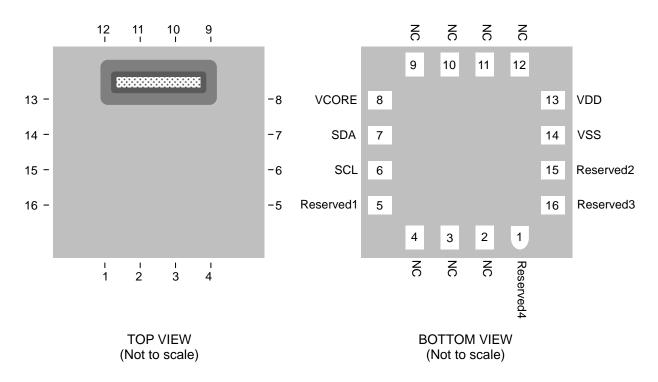
Notice The content of this data sheet is subject to change without prior notice.

In the absence of confirmation by device specification sheets, SHARP takes no responsibility for any defects that may occur in equipment using any SHARP devices shown in catalogs, data books, etc. Contact SHARP in order to obtain the latest device specification sheets before using any SHARP device.

Block diagram



■ Pin Configuration



| Pin | Pin Name | Туре | Function | Remarks |
|-----|-----------|-------|--|--|
| 1 | Reserved4 | - | Test Terminal | Leave Open |
| 2 | NC | - | Not Connected | Leave Open |
| 3 | NC | - | Not Connected | Leave Open |
| 4 | NC | - | Not Connected | Leave Open |
| 5 | Reserved1 | - | Test Terminal | Leave Open |
| 6 | SCL | I | I ² C Serial Clock | - |
| 7 | SDA | I/O | I ² C Serial Data | - |
| 8 | VCORE | Power | Core voltage: Decoupling input for internal circuitry. | Always connect to an external capacitor(0.1uF) to GND. |
| 9 | NC | - | Not Connected | Leave Open |
| 10 | NC | - | Not Connected | Leave Open |
| 11 | NC | - | Not Connected | Leave Open |
| 12 | NC | - | Not Connected | Leave Open |
| 13 | VDD | Power | Power Supply | - |
| 14 | VSS | Power | GND | - |
| 15 | Reserved2 | - | Test Terminal | Leave Open |
| 16 | Reserved3 | - | Test Terminal | Leave Open |

Electrical Characteristics

Absolute Maximum Ratings

| Parameter | Symbol | Ratings | Unit | Remarks |
|---------------------|--------|-----------------|------|---------|
| VDD to GND | - | -0.3 to 6.0 | V | |
| SDA/SCL to GND | - | -0.3 to VDD+0.3 | V | |
| Storage Temperature | - | -40 to 125 | °C | |

Note that operation of the device at these conditions is not implied and may affect the performance, reliability or life of the device.



This product is ESD sensitive. In order to prevent deterioration or damage due to ESD, this product must be protected against static electricity at all times.

Recommended Operating Conditions

| Parameter | Symbol | Min | Тур. | Max | Unit | Remarks |
|--|--------------------|------|------|------|------|--|
| Power Supply | VDD | 2.7 | | 5.5 | V | |
| Ambient Temperature | T _A | -20 | | 85 | °C | |
| I ² C Pull-Up Register | R _₽ | 1 | 2.2 | | kΩ | |
| External Capacitance between VCORE and GND | C_{VCORE} | 0.09 | 0.1 | 0.33 | μF | Must be connected between VCORE and GND |

DC Electrical Characteristics

(Conditions at $V_{DD}=3V$ or 5V, $T_A=25^{\circ}C$ unless otherwise noted.)

| Parameter | Symbol | Conditions | Min. | Тур. | Max. | Unit |
|-----------------------|------------------|-------------|------|------|-------|-----------------|
| Operation Current | I _{DD} | | - | 750 | 1,100 | μA |
| Non-operation Current | I _{NOP} | -20 to 85°C | - | 1 | 3 | μA |
| Power-on-Reset Level | V_{POR} | | 1.6 | 1.7 | 1.75 | V |
| Output Low Voltage | V _{OL} | | - | - | 0.2 | V _{DD} |
| Output Current | I _{OL} | | 1.5 | - | - | mA |
| Input Low Voltage | V _{IL} | | - | - | 0.2 | V _{DD} |
| Input High Voltage | V _{IH} | | 0.8 | - | - | V _{DD} |
| Input Current | l _{IL} | | | | 10 | μA |

Relative Humidity Sensor

(Conditions at $V_{DD}=3V$, $T_A=25^{\circ}C$ unless otherwise noted.)

| Parameter | Symbol | Conditions | Min. | Тур. | Max. | Unit |
|------------------------------|--------|-----------------|---|------|------|------|
| . 12 | | Typical at 25°C | - | ±2 | TBD | %RH |
| Accuracy ^{1,2} | | -20 to 85°C | See figure "Relative humidity sensor accuracy" below | | %RH | |
| Resolution | | | - | 0.1 | - | %RH |
| Hysteresis | | | - | ±1 | - | %RH |
| Repeatability | | | - | 0.1 | - | %RH |
| Response Time ³ | | 1m/s air flow | - | TBD | - | sec |
| Operating Range ⁴ | | | 0 | - | 100 | %RH |

Notes

1: Applicable to non-condensing environments only. Excludes hysteresis and certain other factors.

2: Recommended humidity operating range is 20 to 80%RH (non-condensing) over 0 to 60°C.

Prolonged operation beyond these ranges may result in a shift of sensor reading.

3: Time to reach 63% of a step change.

4: Applicable to non-condensing environments only.

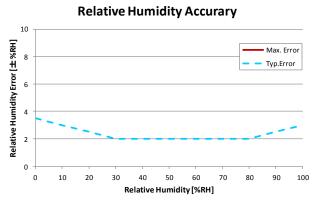
Temperature Sensor

(Conditions at V_{DD}=3V, T_A=25°C unless otherwise noted.)

| Parameter | Symbol | Conditions | Min. | Тур. | Max. | Unit |
|----------------------------|-------------|-----------------|---|-------|------|------|
| | | Typical at 25°C | - | ±0.3 | ±0.5 | °C |
| Accuracy | -20 to 85°C | | See figure "Temperature sensor accuracy" below | | | °C |
| Resolution | | | - | 0.015 | - | °C |
| Repeatability | | | - | 0.1 | - | °C |
| Response Time ¹ | | | - | TBD | - | sec |
| Operating Range | | | -20 | - | 85 | °C |

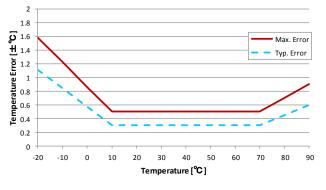
Notes

1: Time to reach 63% of a step change. Response time depends on system thermal mass and air-flow.



[Relative humidity sensor accuracy ($T_A=25^{\circ}C$)]

Temperature Accuracy



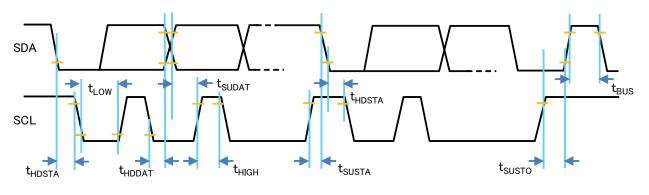
[Temperature sensor accuracy]

AC Characteristics

| Parameter | Symbol | Min | Тур | Max | Unit |
|--|--------------------|-----|-----|-----|------|
| SCL clock Frequency | f _{SCL} | 100 | - | 400 | kHz |
| Start Condition hold time relative to SCL edge | t _{HDSTA} | 0.1 | - | - | μs |
| Minimum SCL clock low width | t _{LOW} | 0.6 | - | - | μs |
| Minimum SCL clock high width | t _{HIGH} | 0.6 | - | - | μs |
| Start condition setup time relative to SCL edge | t _{susta} | 0.1 | - | - | μs |
| Data hold time on SDA relative to SCL edge | t _{HDDAT} | 0 | - | 0.5 | μs |
| Data setup time on SDA relative to SCL edge | t _{SUDAT} | 0.1 | - | - | μs |
| Stop condition setup time on SCL | t _{susto} | 0.1 | - | - | μs |
| Bus free time between stop condition and start condition | t _{BUS} | 1 | - | - | μs |

Note)

For more information on I²C specification, please refer to the following Website: http://www.nxp.com/documents/other/UM10204_v5.pdf



I²C Timing Diagram

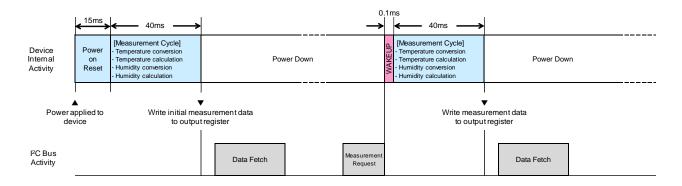
Operation

I²C Interface

This product communicates with I2C-compatible protocol with support for 100kHz and 400kHz bit rates. All sensors are set to the same I2C slave address (28H).

Note) For more information on I²C specification, please refer to the following Website: http://www.nxp.com/documents/other/UM10204_v5.pdf

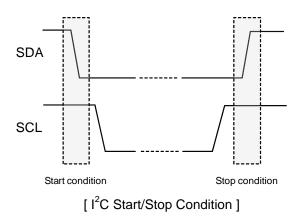
The overview of the measurement sequence is as follows:



[I²C Measurement Sequence]

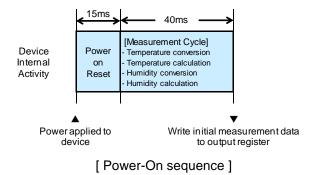
I²C-BUS is a bi-directional 2-wire serial bus, consists of serial data line (SDA) and serial data clock (SCL). When the bus is free, both SDA and SCL are HIGH.

Each communication sequence begins with a Start Condition, and ends with a Stop Condition. A Start Condition is defined as a HIGH to LOW transition on the SDA line while SCL is HIGH. A Stop Condition is defined as a LOW to HIGH transition on the SDA line while SCL is HIGH. Between the Start and Stop conditions, the data on the SDA can change when SCL is LOW and the data is fetched during SCL is HIGH. Each data bit is transferred by one clock pulse of SCL.



Startup

Through the system power-on reset (POR) after power-up, the sensor will perform an initial measurement cycle. This initial measurement data is written to the output register. The sensor needs at most 55ms to be ready for fetching data. SCL keeps HIGH during this period.



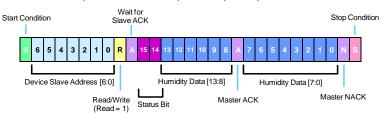
Data Fetch

The Data Fetch (DF) command is used to fetch humidity and temperature measurement data from the output register. The master issues a Start Condition, followed by the 7-bit slave address 28H ('010'1000') and the 8th bit=1 (Read). The sensor sends an acknowledge (ACK) when receiving the command from the master properly. The 14 bits of humidity data are fetched in the first two bytes. The higher 2 bits of the first byte are the status bits. After the humidity data, the 14 bits of temperature data can be fetched. The last two bits of the fourth byte are undetermined and should be masked off in the application.

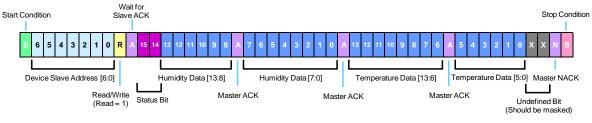
| $[^{2}($ | C slave | address | 1 |
|-----------|----------|---------|----|
| | 0 0.0.00 | 4441000 | ы. |

| A6 | A5 | A4 | A3 | A2 | A1 | A0 |
|----|----|----|----|----|----|----|
| 0 | 1 | 0 | 1 | 0 | 0 | 0 |

■ I²C Data Fetch - 2 Bytes: Slave returns only 2 humidity data bytes to master



■ I²C Data Fetch - 4 Bytes: Slave returns 2 humidity data bytes & 2 temperature data bytes to master



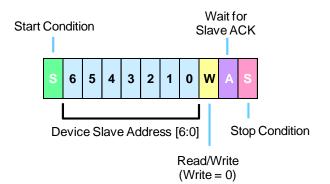




Measurement Request

After the measurement cycle, the sensor goes to power down to suppress power consumption. To wake up the part from power down and start a new measurement cycle, the master sends an MR (Measurement Request) command. The master issues a Start Condition, followed by the 7-bit slave address 28H('010'1000') and the 8th bit=0(Write). When receiving the command from the master properly, the sensor sends an acknowledge (ACK) by lowering SDA automatically. Then the master sends a Stop Condition. When a MR is received properly, the part wakes up with a small period and then a new measurement cycle is performed.

Another MR can be sent to start a new measurement cycle without fetching the previous data.



[I²C Measurement Request: slave starts a measurement cycle]

Output Data Conversion

[Relative Humidity Conversion] The Humidity Data bytes (14 bits raw value) can be converted to %RH using the following equation:

Relative Humidity[%RH] = $\frac{\text{Humidity Data}[13:0]}{2^{14}} \times 100$

[Temperature Conversion]

The Temperature Data bytes (14 bits raw value) can be converted to °C using the following equation:

Temperature[°C] =
$$\frac{\text{Temperature Data}[13:0]}{2^{14}} \times 165 - 40$$

Application circuit example

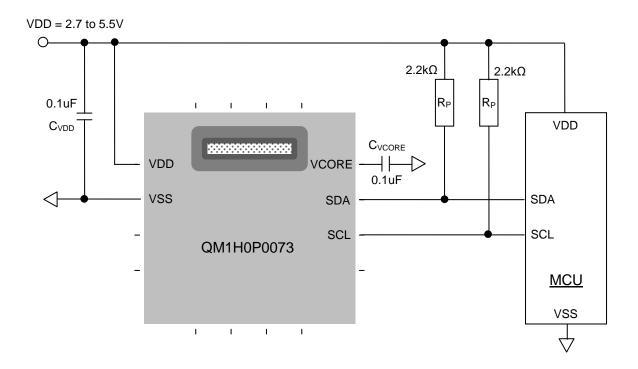
The following shows the application circuit example.

Both SDA and SCL are connected to VDD via pull-up resisters R_P . When the bus is free, both lines are HIGH. The values of the pull-up resisters are determined in consideration of the capacitance of the I^2C bus lines. Note that I^2C pull-up resisters may be integrated in I/O of MCUs.



Be sure to connect C_{VCORE} with appropriate value between VCORE terminal and GND. If C_{VCORE} is not connected, or if the value is not appropriate, it may affects the measurement accuracy of temeperature and relative humidity.

In order to stably operate this product, C_{VDD} and C_{VCORE} should be as close to this device as possible.



■ Soldering Conditions

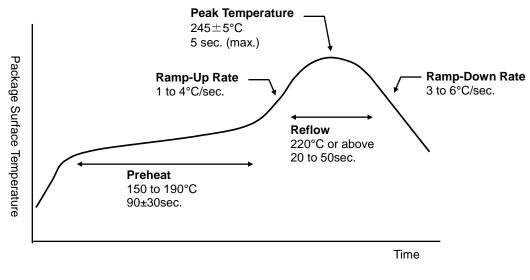
Soldering methods and suitability of this product

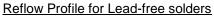
| Soldering methods | Reflow soldering | Flow(dip, wave) soldering | Hand soldering by soldering iron | Hot plate Soldering |
|-------------------|------------------|-------------------------------|-------------------------------------|------------------------|
| Suitability | Ο | Not suitable for this product | Not suitable for this product | Ο |

Reflow Soldering

The following conditions are recommended for reflow soldering this product by lead-free solder.

| Parameter | Recommended Condition |
|------------------------|------------------------------------|
| Type of process | Convection or IR/Convection reflow |
| Atmosphere | Air or Nitrogen |
| Number of reflow cycle | 🔥 1time only |





Hot Plate Soldering

Recommended hot plate soldering conditions is as follows :

| Parameter | Recommended Condition |
|-------------------------|-----------------------|
| PCB surface temperature | < 250°C |
| Soldering time | < 5 sec. |

Rework



Hot air reworking is not recommended as the hot air may cause irreversible damage for humidity sensor elements.

Removed device should not be reused because of the possibility of thermal and mechanical damage in rework.

Notice of soldering

- ▲ Only one reflow process is allowed for this product. In case the PCB passes through multiple solder cycles, it is strongly recommended to assemble this product only in the last solder cycle.
- Ensure good ventilation in assembly lines. If any volatile gas exists, it may cause damage to this product.
- If possible, it is recommended to mount this product after all materials that are used in the assembly process have completely cured or dried out.
- After soldering, the devices may read a slight offset. One of the following rehydration processes(TBD) may eliminate the offset.
 - a) Store the devices at >75%RH for at least 12 hours
 - b) Expose the devices to >40%RH for at least 5 days
- Keep the opening of humidity sensors clean and undamaged.
- Do not wash the PCB after reflow soldering or hand soldering. It may affect the accuracy of humidity sensors. "No clean" type solder paste is strongly recommended.
- Contamination of the humidity sensor element by flux shall be avoided. Liquid flux is not recommended.

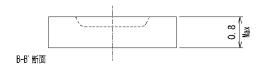
CONFIDENTIAL

Package Outline

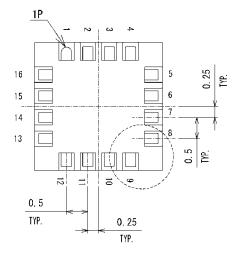
TOP VIEW

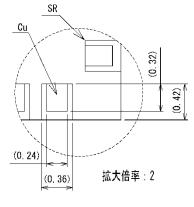
All dimensions in units of [mm]

SIDE VIEW



BOTTOM VIEW



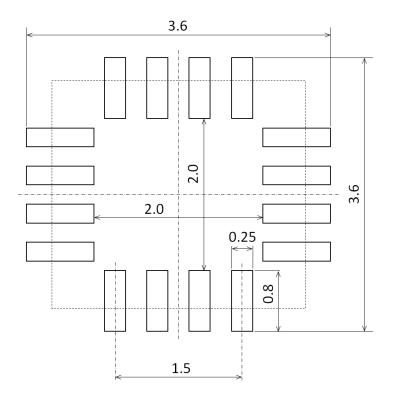


Product mass : 0.013±0.005g

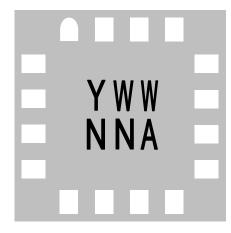


PCB Land Pattern

All dimensions in units of [mm]



Marking



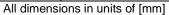
BOTTOM VIEW (Not to scale)

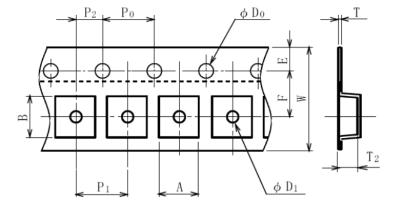
| Symbol | Name | Remarks |
|--------|-------------------------------|--|
| Y | Last one digit of the year | 1 digit number Y="0" to "9" |
| WW | Week | 2 digit number WW="00" to "53" |
| NN | Assembly lot | 2 digit number NN="00" to "99" |
| А | Product name | 1 alphabetic digit A="1" : QM1H0P0073 |

■ Tape and Reel Specifications

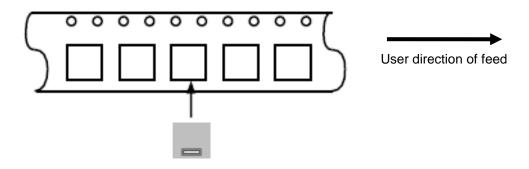
Tape structure and dimensions

| Index | Dimensions | |
|--|----------------|--|
| A | 3.3±0.1 | |
| В | 3.3±0.1 | |
| D0 | φ1.5 +0.1/-0 | |
| D1 | φ1.5 +0.1/-0 | |
| E | 1.75±0.1 | |
| F | 5.5±0.05 | |
| P0 | 4.0±0.1 | |
| P1 | 8.0±0.1 | |
| P2 | 2.0±0.05 | |
| Т | 0.3±0.05 | |
| T2 | 0.9±0.05 | |
| W | 12.0 +0.3/-0.1 | |
| All align an align a light white of [game] | | |



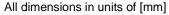


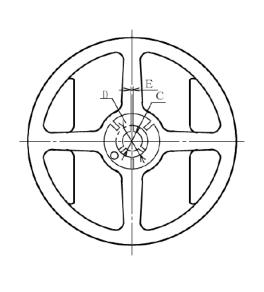
1pin orientation in tape

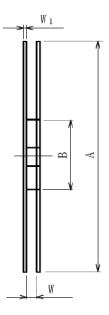


Reel structure and dimensions

| Index | Dimensions | |
|---------------------------------|-------------------|--|
| А | φ180 +0/-1.5 | |
| В | φ60 + 1/-0 | |
| С | φ13±0.2 | |
| D | φ21±0.8 | |
| E | 2.0±0.5 | |
| W | 13.0 +1.0/-0 | |
| W1 | 1.2 | |
| All dimensions in units of [mm] | | |







Precaution for Use

Effect of temperature

Since the relative humidity strongly depends on temperature, be careful of the following points:

- Keep the temperature of humidity sensors same as temperature of the air which is measurement subject of relative humidity.
- If this product is mounted close to the heating component, it should be considered to prevent heat transfer or to keep it as low as possible.

Exposure to chemicals

Exposure to the following chemicals may cause irreversible effects. Avoid exposure to such chemicals and provide sufficient ventilation.

• Volatile chemicals

Example: Acetone, Ethanol, Isopropyl Alcohol, Toluene, etc.

These volatile chemicals also exist in epoxy compounds, adhesives, adhesive tapes, etc, and may be emitted as outgas component.

- Acids and bases
 - Example: HCI, H₂SO₄, HNO₃, NH₃, etc.
 - High concentration Ozone or H_2O_2
- Cleaning agents

Example: Alcohol, detergents, brominated/fluorinated solvents, etc Do not apply PCB board wash after soldering.

Exposure to extreme environment

Prolonged exposure to very low/high humidity environment may cause gradual shifts of the relative humidity reading and errors may increase. In order to eliminate these errors, the following procedure is useful.

[In case of very low humidity]

The performance of the humidity sensor can be recovered after a few days under typical ambient conditions(40 - 60%RH).

[In case of very high humidity]

Compared with exposure to very low humidity, recovery of sensor performance may be slower. In this case, the following bake and rehydration procedure can accelerate recovery.

Baking : TBD

Rehydration: TBD

Following this procedure, the performance of the humidity sensor will recover after a few days under typical ambient conditions.

Packing material

Because both sensors as a part and sensors mounted on the final product need to avoid contamination by outgas emitted from packing materials, careful attention must be paid in the selection of the packaging materials.

- Avoid using adhesives, adhesive tapes and stickers as much as possible.
- Do not use antistatic polyethylene bags.
- Be very careful to use foamed plastics.

Hygroscopic material

Since hot melts may absorb moisture and affect the response time of the relative humidity sensor, using hot melt sparingly is recommended.

Protection of the sensor opening

Avoid adhering contaminants (e.g. liquids (especially salt water), solvents, fats, dust, etc.) so as not to affect sensor performance. Care must also be taken to the following points for protection of the sensor opening.

- Do not cover the sensor opening by any adhesive tapes (e.g. Scotch Tape, Sellotape, etc.) which may affect sensor performance by outgas.
- Avoid covering the sensor opening with coatings.
- Do not directly touch the sensor opening.

Others

- This product is NOT intended for use in the following special environments, such as:
 - Use in liquids such as water, oil, chemical, and organic solvent.
 - Use under direct sunlight, in outdoor, heat and dusty atmospheres.
 - Use in places full of corrosive gases such as sea breeze, SO₂, H₂S, Cl₂, NH₃, acid, and alkali.
 - Use in environment with strong electromagnetic waves or large static electricity.
 - Use in such a place where the product is condensation or freezing.
- This product is not designed to be radiation-resistant.

Important Notices

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- The content of this data sheet is subject to change without prior notice. Contact SHARP in order to obtain the latest device specification sheets before using any SHARP device. In the absence of confirmation by device specification sheets, SHARP takes no responsibility for any defects that may occur in equipment using any SHARP devices shown in catalogs, data books, etc.
- When using this product, please observe the absolute maximum ratings and the instructions for use outlined in this document, as well as the precautions mentioned below. Sharp assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in this document, and the precautions mentioned below:

(Precautions)

- 1. Please do verify the validity of this part after assembling it in customer's products, when customer wants to make catalogue and instruction manual based on the specification sheet of this part.
- 2. This product is designed for use in the following application areas:
 - Personal computers
 - Office automation equipment
 - Telecommunication equipment (terminal)
 - Test and measurement equipment
 - Industrial control
 - Audio visual equipment
 - Consumer electronics

- 3. Appropriate measures, such as fail-safe design and redundant design considering the safety design of the overall system and equipment, should be taken to ensure reliability and safety when this product is used for equipment which demands high reliability and safety in function and precision, such as:
 - Transportation control and safety equipment (aircraft, train, automobile etc.)
 - Traffic signals
 - Gas leakage sensor breakers
 - Rescue and security equipment
 - Other safety equipment etc
- 4. Please do not use this product for equipment which require extremely high reliability and safety in function and precision, such as:
 - Space equipment
 - Telecommunication equipment (for trunk lines)
 - Nuclear power control equipment
 - Medical equipment
- 5. Please contact and consult with a Sharp sales representative if four are any questions regarding interpretation of the above four paragraphs.
- Please contact and consult with Sharp sales representative for any questions about this product.

If the use of the product in the above application areas is for equipment listed in paragraphs(3) or (4), please be sure to observe the precautions given in those respective paragraphs.

Revision History

| Date | Rev. | Changes |
|------------|------|--|
| 2013.08.09 | 0.1 | Created preliminary version |
| 2013.08.27 | A | Updated Features/Pin name and Functions Updated Pin layout and lock diagram |
| 2013.10.03 | 0.2 | Fully revised |
| 2013.10.30 | 0.3 | Added Model No. |
| 2014.02.07 | 0.4 | Fully revised |
| 2014.04.17 | 0.5 | p.14-15 Soldering Conditions: Fully modified p.16 Package Outline: Modified package thickness |
| 2014.06.18 | 0.6 | Revised the following drawings Block Diagram, Pin Configuration, Application Circuit Example, Package Outline Added capacitance(0.1uF) of VCORE terminal on Pin Configuration Added "Storage Temperature" to Absolute Maximum Ratings Added "External Capacitance between VCORE and GND" to Recommended Operating Conditions Revised voltage condition on DC Electrical Characteristics to "V_{DD}=3V or 5V" Revised voltage condition on Relative Humidity Sensor and Temperature Sensor to "V_{DD}=3V" Added max value of accuracy(typical at T_A=25°C) on Relative Humidity Sensor Added notices to "Application Circuit Example" Updated notices on Soldering Conditions Added "PCB Land Pattern" section Updated Marking Added "Tape and Reel Specification" section Updated Precaution for Use |